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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Naoki TEGA	06/26/2007
Hiroshi MIKI	06/27/2007
Yasuhiro SHIMAMOTO	06/27/2007
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Tetsuya ISHIMARU	07/02/2007

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11773842

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NAME OF SUBMITTER:	Mitchell W. Shapiro

PATENT REEL: 019523 FRAME: 0201

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Total Attachments: 1

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PATENT REEL: 019523 FRAME: 0202

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by RENESAS TECHNOLOGY CORP., a corporation organized under the laws of Japan, located at 6-2, Otemachi 2-chome, Chiyoda-ku, Tokyo 100-0004, Japan, receipt of which is hereby acknowledged I do hereby soil and assign to said RENESAS TECHNOLOGY CORP., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME

Invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said RENESAS TECHNOLOGY CORP., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, tawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to Issue said Lettors Patent to said RENESAS TECHNOLOGY CORP.

Signed on the date(s) indicated aside signatures:

	INVENTOR(S)	Date Signed
	(発明者フルネームサイン)	(署名日)
1)	Naski Jega (Naski TEGA)	6/26 /2007
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• •		

PATENT REEL: 019523 FRAME: 0203

RECORDED: 07/06/2007